

# GPI6508DFIC

#### GaN Power IC in DFN5x6 Package

#### Preliminary Datasheet version: 2.0

#### **Features**

BV <sub>dss</sub>	R <sub>dson</sub>	l <sub>ds</sub>	
650V	170 mΩ	7.5 A	

- Ultra-low RDS(on)
- High dv/dt capability
- Extremely low input capacitance
- Fast switching
- Low Profile

#### **Applications**

- Switching Power Applications
- Power adapters and power delivery chargers

#### **Description**

These devices are power IC based on 650 V Power GaN HEMTs using proprietary E-mode GaN on silicon technology. The gate driver is integrated with the main power transistor resulting in fast switching, high system power density and low cost.

### **Device Characteristics**







Basic Parameters			Test data				
	Parameters		Conditions	Min	Typical	Max	Unit
1	BV <sub>dss</sub>	Drain-Source breakdown voltage	V <sub>gs</sub> =0V I <sub>d</sub> =10uA		650		V
2	$R_{dson}$	Static drain-source on resistance, $T_C = 25^{\circ}C$	V <sub>gs</sub> =6V I <sub>d</sub> =1.8A	165	170	190	mΩ
3	Vdd	Drive supply voltage		5	6.5	8	
4	Vin	PWM input pin voltage		5	6.5	8	
5	lin	Input current			1		mA
6	Ciss	Input capacitance			3		pF
7	Qg	Input gate charge			60		fC
Switching Performance			Test data				
-	Parameters		Conditions	Min	Typical	Max	Unit
1	t <sub>d(on)</sub>	Turn-on delay time	V <sub>ds</sub> =350V		15		ns
2	tr	Rise time	Ids 5550   Id=2.5A   Vin=5V   Vdd=6.5V		10		ns
3	t <sub>d(off)</sub>	Turn-off delay time			10		ns
4	t <sub>f</sub>	Fall time			10		ns

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# **Electrical Performance**





## Package Information







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# COMMON DIMENSIONS (UNITS OF MEASURE=MILLIMETER)

SYMBOL	MIN	NOM	MAX		
А	0.90	1.00	1.10		
A1	0.00	0.02	0.05		
A3	0.203REF				
b	0.20 0.25 0.30				
b1	0.225	0.275	0.325		
D	5.90	6.00	6.10		
E	4.90	5.00	5.10		
D2	2.15	2.25	2.35		
E2	4.27	4.37	4.47		
D3	0.20	0.30	0.40		
E3	0.65	0.75	0.85		
D4	0.20	0.30	0.40		
E4	4.525	4.625	4.725		
е	0.375	0.475	0.575		
e1	0.725	0.825	0.925		
e2	0.55	0.65	0.75		
Н	0.35REF				
K	0.35	0.50	0.65		
K1	2.10	2.25	2.40		
L	0.40	0.50	0.60		
L1	0.40	0.50	0.60		

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## **GaN HEMT Frequently Asked Questions**

1	Q: Can we do pin to pin switch for silicon MOSFET or IGBT?
	A: The short answer is no. GaN HEMT power devices are far superior than the best silicon
	devices such as super junction MOSFETs. However, due to different requirements of gate
	driving voltage and extremely high dv/dt slew rate, special drivers and optimized PCB layouts
	are recommended to minimize the impact from circuit parasitics. Some packaging forms such
	as GaNPower's DFN packaged devices offer both sense and force for the source terminal. Also, for traditional TO220 packages, please be advised that the pins are arranged as Gate – Source
	-Drain, and the thermal pad is connected to the source instead of drain.
2	Q: Are GaN power devices reliable?
2	A: GaN power HEMTs have been tested by GaNPower and many other vendors, users and
	testing facilities to be as reliable (if not better than) silicon counterparts.
3	Q: How do GaN power devices compare with SiC?
	A: Currently GaN power HEMT devices are most suitable for low to medium voltage ( $\leq$ 1200V)
	and power (<50KW) applications.
4	Q: Do we need to parallel an FRD for applications such as inverters?
	A: GaN devices are different from silicon MOSFET or IGBT in that they have no inherent PN
	junction diodes that cause reverse recovery issue. User do not need to parallel an FRD for the
	purpose of suppressing the body diode reverse recovery effect, since GaN HEMT can operate
	in both first and third quadrants. However, care should be taken for the dead time power loss
	since the Vsd voltage of GaN HEMT is usually close to 2V. This is especially true when a negative
-	gate voltage is applied.
5	Q: Can we parallel GaN HEMT devices?
	A: Yes, GaN HEMT is ideal for paralleling, due to positive temperature coefficient of Rdson
	and slightly positive temperature coefficient of threshold voltage.